

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Ling CHEN et al.

Docket No.

AM-5209.D2

Application No. 10/693,775	Filing Date 10/24/03	Examiner T. Nguyen	Customer No. 2813	Group Art Unit 2813	Confirmation No. 1973
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Invention: TANTALUM BARRIER LAYER FOR COPPER METALLIZATION

COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	42 -	41 =	1	x \$18.00	\$18.00
INDEP. CLAIMS	10 -	8 =	2	x \$86.00	\$172.00
Multiple Dependent Claims (check if applicable)		<input type="checkbox"/>			\$0.00
					TOTAL ADDITIONAL FEE FOR THIS AMENDMENT
					\$190.00

No additional fee is required for amendment.

Please charge Deposit Account No. _____ in the amount of _____.

A check in the amount of \$190.00 to cover the filing fee is enclosed.

The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0636

- Any additional filing fees required under 37 C.F.R. 1.16.
- Any patent application processing fees under 37 CFR 1.17.

Charles S. Guenzer
Signature

Dated: July 21, 2004

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I certify that this document and fee is being deposited on July 21, 2004 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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